

Electronic Patent Application Fee Transmittal

Application Number:	10591580			
Filing Date:	05-Sep-2006			
Title of Invention:	Heat-resistant resin laminated film, multilayer film with metal layer including same and semiconductor device			
First Named Inventor/Applicant Name:	Takuo Watanabe			
Filer:	Deborah Sue Gladstein/Gail Frohnert			
Attorney Docket Number:	358682001300			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 2 months with \$0 paid	1252	1	460	460

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				460